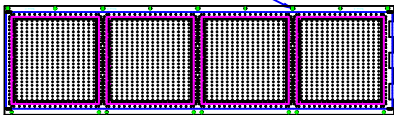


框架传送方向 (装片):

L/F Direction (D/A): 椭圆孔



注意: 基岛全镀银

实物图:

Chip photo:

特殊说明 Special Instructions:

DFN8L(2×3×0.5-P0.5)(68×41mil²)(4 block)
(1720×1050um²)